

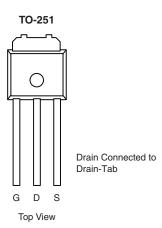
RoHS

COMPLIANT

SUU15N15-95-VB Datasheet

N-Channel 200V (D-S) MOSFET

PRODUCT SUMMARY				
V _{DS} (V)	R _{DS(on)} (Ω)	I _D (A)		
200	0.056 at V _{GS} = 10 V	25		
	0.070 at V _{GS} = 6 V	23		

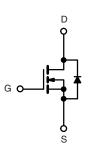


FEATURES

- Trench Power MOSFET
- 175 °C Junction Temperature
- PWM Optimized
- 100 % R_g Tested
- Compliant to RoHS Directive 2002/95/EC

APPLICATIONS

• Primary Side Switch



N-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS ($T_A = 25 \degree C$, unless otherwise noted)					
Parameter		Symbol	Limit	Unit	
Drain-Source Voltage		V _{DS}	200	V	
Gate-Source Voltage	V _{GS}	± 20	v		
	T _C = 25 °C	1-	25		
Continuous Drain Current $(T_J = 175 \ ^{\circ}C)^b$	T _C = 125 °C	I I _D	17		
Pulsed Drain Current	I _{DM}	60	А		
Continuous Source Current (Diode Conduction)	۱ _S	19			
Avalanche Current	I _{AS}	25			
Single Pulse Avalanche Energy	L = 0.1 mH	E _{AS}	18	mJ	
Maximum Dawar Dissinction	T _C = 25 °C	P _D	145 ^b	w	
Maximum Power Dissipation	T _A = 25 °C		3.5 ^a	vv	
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 175	°C	

THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Typical	Maximum	Unit	
	t ≤ 10 s	R _{thJA}	15	18	°C/W	
Junction-to-Ambient ^a	Steady State		40	50		
Junction-to-Case (Drain)	•	R _{thJC}	0.85	1.1		

Notes:

a. Surface mounted on 1" x 1" FR4 board.

b. See SOA curve for voltage derating.

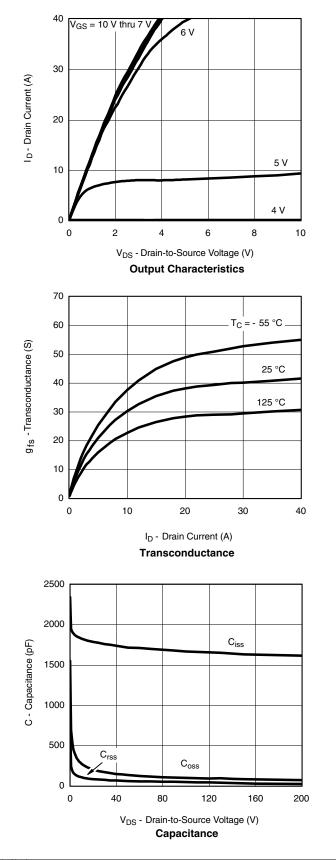
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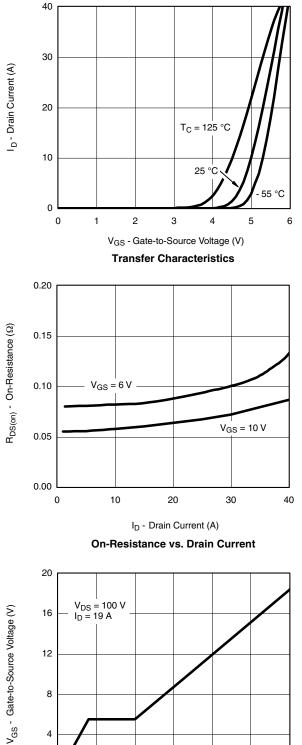
Parameter	Symbol	Test Conditions	Min.	Typ. ^a	Max.	Unit	
Static		·					
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 \text{ V}, \text{ I}_{D} = 250 \mu\text{A}$	200	200		V	
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = 250 \ \mu A$	2		4	- V	
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 20 V$			± 100	nA	
		$V_{DS} = 200 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$	1		1		
Zero Gate Voltage Drain Current	I _{DSS}	V_{DS} = 200 V, V_{GS} = 0 V, T_{J} = 125 °C			50	50 μA 250	
		$V_{DS} = 200 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 175 ^{\circ}\text{C}$			250		
On-State Drain Current ^b	I _{D(on)}	$V_{DS} = 5 V, V_{GS} = 10 V$	40			А	
		V _{GS} = 10 V, I _D = 5 A		0.056			
	D	$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 5 \text{ A}, \text{ T}_{J} = 125 ^{\circ}\text{C}$		0.130		Ω	
Drain-Source On-State Resistance ^b	R _{DS(on)}	$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 5 \text{ A}, \text{ T}_{J} = 175 \text{ °C}$		0.260			
		$V_{GS} = 6 V, I_D = 5 A$		0.070			
Forward Transconductance ^b	9 _{fs}	V _{DS} = 15 V, I _D = 19 A		35		S	
Dynamic ^a							
Input Capacitance	C _{iss}			2400			
Output Capacitance	C _{oss}	V_{GS} = 0 V, V_{DS} = 25 V, F = 1 MHz		280		pF	
Reverse Transfer Capacitance	C _{rss}			180		1	
Total Gate Charge ^c	Qg			40			
Gate-Source Charge ^c	Q _{gs}	V_{DS} = 100 V, V_{GS} = 10 V, I_{D} = 19 A		10		nC	
Gate-Drain Charge ^c	Q _{gd}			15			
Gate Resistance	R _g		0.5		2.9	Ω	
Turn-On Delay Time ^c	t _{d(on)}			15	25		
Rise Time ^c	t _r	V_{DD} = 100 V, R_L = 5.2 Ω		50	75		
Turn-Off Delay Time ^c	t _{d(off)}	$\text{I}_\text{D}\cong$ 19 A, V_GEN = 10 V, R_g = 2.5 Ω		30	45	- ns	
Fall Time ^c	t _f			60	90		
Source-Drain Diode Ratings and Char	acteristics (1	Γ _C = 25 °C)					
Pulsed Current	I _{SM}				50	А	
Diode Forward Voltage ^b	V _{SD}	$I_{F} = 19 \text{ A}, \text{ V}_{GS} = 0 \text{ V}$		0.9	1.5	V	
Source-Drain Reverse Recovery Time	t _{rr}	I _F = 19 A, dl/dt = 100 A/μs		180	250	ns	

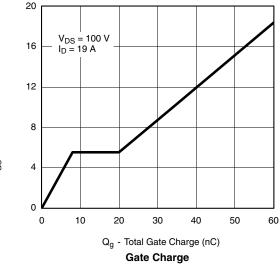
Notes: a. Guaranteed by design, not subject to production testing. b. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %. c. Independent of operating temperature.



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)







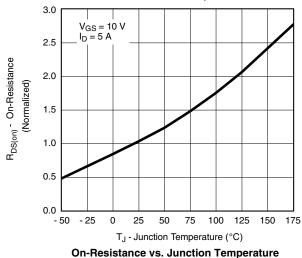


T_J = 25 °C

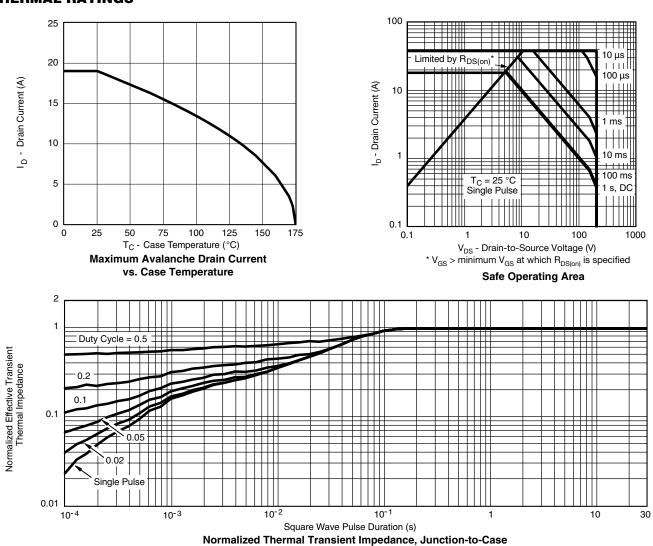
0.9

1.2





THERMAL RATINGS



100

10

1

0

0.3

T_J = 150 °C

0.6

Source-Drain Diode Forward Voltage

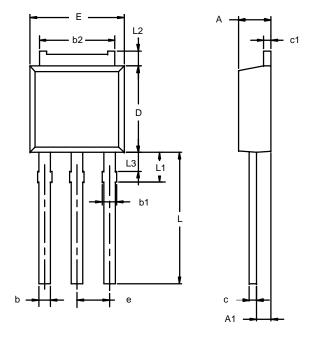
V_{SD} - Source-to-Drain Voltage (V)

I_S - Source Current (A)

SUU15N15-95-VB



TO-251AA



	MILLIM	IETERS	INC	HES	
Dim	Min	Max	Min	Max	
Α	2.21	2.38	0.087	0.094	
A1	0.89	1.14	0.035	0.045	
b	0.71	0.89	0.028	0.035	
b1	0.76	1.14	0.030	0.045	
b2	5.23	5.43	0.206	0.214	
С	0.46	0.58	0.018	0.023	
c1	0.46	0.58	0.018	0.023	
D	5.97	6.22	0.235	0.245	
E	6.48	6.73	0.255	0.265	
е	2.28 BSC		0.090	BSC	
L	3.89	9.53	0.153	0.375	
L1	1.91	2.28	0.075	0.090	
L2	0.89	1.27	0.035	0.050	
L3	1.15	1.52	0.045	0.060	

Note: Dimension L3 is for reference only.



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